



**SUGGESTED PCB LAYOUT
(COMPONENT SIDE)**

**PCB LAYOUT
TOLERANCE
.XX±0.05[0.002]**

HOUSING: HIGH TEMP. THERMOPLASTIC, BLACK, UL 94V-0
 CONTACTS: 0.014 INCHES (0.35 MILLIMETERS) THICK PHOSPHOR BRONZE PLATED WITH
 150 MICRONS (3.81 MICROMETERS) MINIMUM THICK TIN LEAD IN SOLDER AREA.
 15 MICRONS (0.38 MICROMETERS) MINIMUM GOLD IN LOCALIZED PLATE AREA.
 ENTIRE CONTACTS PLATED WITH 50 MICRONS (1.27 MICROMETERS) MINIMUM THICK NICKEL.

- JACK CAVITY CONFORMS TO FCC RULES AND REGULATIONS PART 68, SUBPART F
- PART NUMBER: XRJ-U-06-8-B-X-F2

REFER TO LED OPTIONS TABLE FOR ORDERING CODES

NOTES: UNLESS OTHERWISE SPECIFIED
 UNSPECIFIED TOLERANCE: .XX±0.25[0.010]
 .X±0.30[0.012]

XMULTIPLE		CONNECTING THE INFORMATION AGE
XMULTIPLE ASIA SP. No. 80, Puchong BL, Tanjung, U.K.A. Cyberway, S.O.C.	XMULTIPLE USA 3055 Old Cottage Road Newbury Park, CA 91350	SNO:
THIS DRAWING IS A CONTROLLED DOCUMENT.		DRAW NO: PDU08-802
TITLE: RJ45 Connectors, W/LED, SP, BC, Unshielded, Thru-Hole	PART NO: XRJM-U-08-8-B-X-F2	DRAW: VHQ
DRAWN:	SHEET 1 of 1	ENGR: C. TSAI
DATE: 10/06/01	REV J	